




General

- Slow Blow
- 3.10mm×1.55mm physical size
- Thick film manufacturing method, ceramic substrate, silver fusing element
- -50°C~125°C operating temperature
- Excellent environmental integrity
- RoHS compliant
- Halogen-free

Agency / Certificate Information

| Agency | File Number | Ampere Range |
|--|---------------|--------------|
|  | JDYX2.E319512 | 1A~7A |
| | JDYX8.E319512 | 1A~7A |

Application

- Battery pack
- LED driver
- Car charger
- Portable devices (battery charger, etc.)
- Game equipment
- LCD monitor, LCD modules
- Wireless base station

Ordering Information

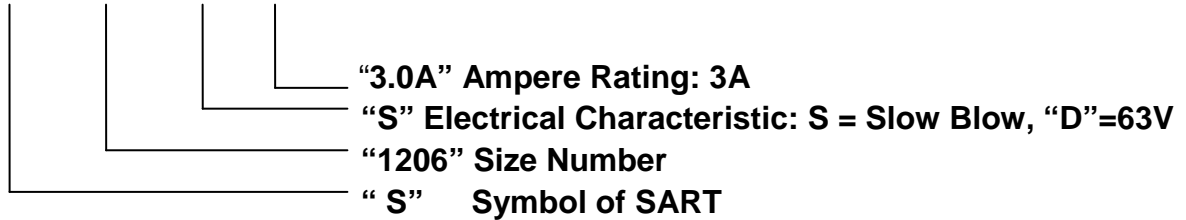
| Part Number | Marking | Current Rating (A) | Voltage Rating (V) | Interrupting Rating | Max Cold DCR* (Ω) | Typical I ² T** (A ² S) |
|---------------|---------|--------------------|--------------------|-------------------------|-------------------|---|
| S1206-SD-1.0A | H | 1.0 | 63 | 50A 63V DC 63V AC | 0.380 | 0.245 |
| S1206-SD-1.5A | K | 1.5 | | | 0.200 | 0.294 |
| S1206-SD-2.0A | N | 2.0 | | | 0.105 | 0.788 |
| S1206-SD-2.5A | O | 2.5 | | | 0.078 | 1.149 |
| S1206-SD-3.0A | P | 3.0 | | | 0.045 | 2.300 |
| S1206-SD-3.5A | R | 3.5 | | | 0.037 | 2.563 |
| S1206-SD-4.0A | S | 4.0 | | | 0.028 | 3.667 |
| S1206-SD-5.0A | T | 5.0 | | | 0.020 | 4.260 |
| S1206-SD-6.0A | 6 | 6.0 | | | 0.016 | 9.848 |
| S1206-SD-7.0A | U | 7.0 | | | 0.009 | 11.176 |

* Measured at ≤10% rated current and 25°C

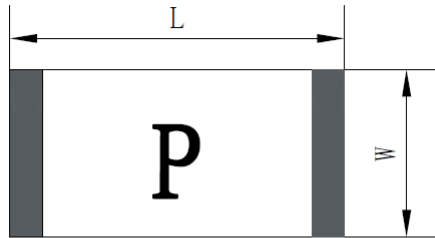
** Melting I²T at 10 times of rated current

Catalog Symbol

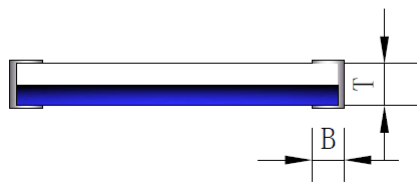
S 1206-SD-3.0A



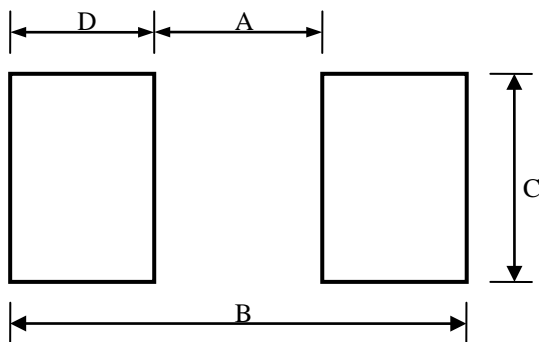
Dimensions



| L(mm) | W(mm) | T(mm) | B(mm) |
|-----------|-----------|-----------|-----------|
| 3.10±0.20 | 1.55±0.20 | 0.55±0.20 | 0.50±0.20 |



Recommended Land Patterns

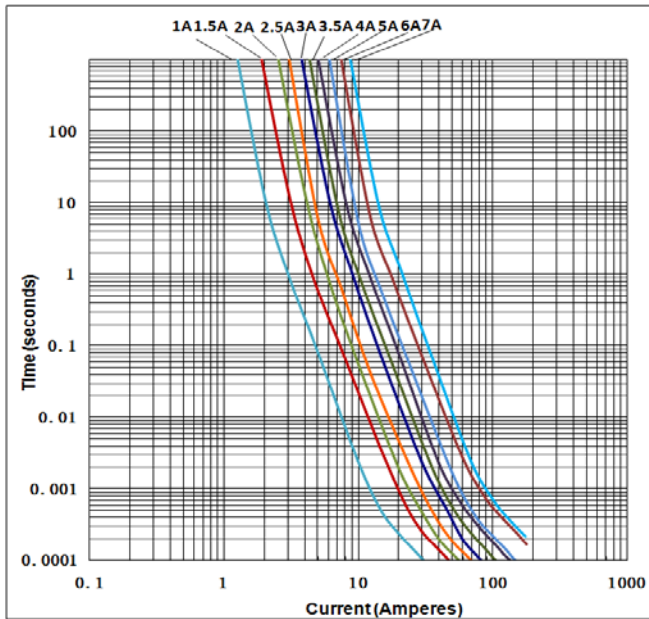


Materials

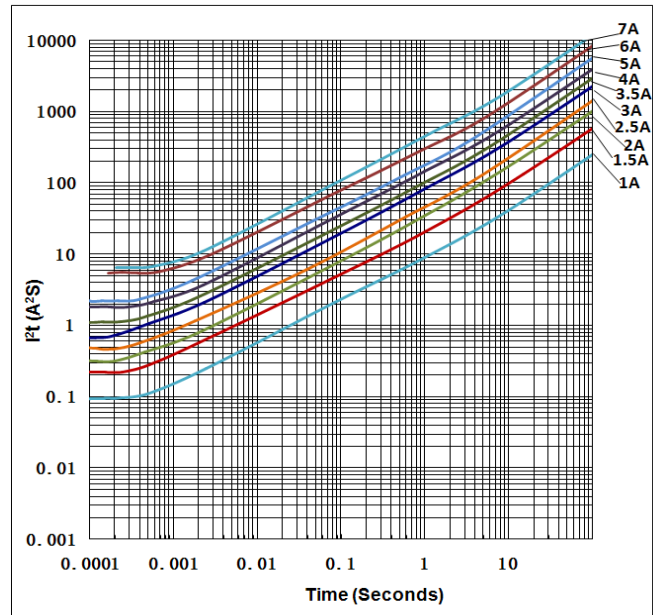
| Components | Material |
|--------------|------------------------------------|
| Substrate | Ceramic |
| Terminations | Silver over-plated with tin (100%) |
| Element | Silver or Silver / Palladium |

| Dimensions | A(mm) | B(mm) | C(mm) | D(mm) |
|------------|-----------|-----------|-----------|-----------|
| Spec | 2.00±0.30 | 4.40±0.50 | 2.40±0.30 | 1.20±0.30 |

Time Current Curve



I²T vs Time Curve



Electrical Characteristics

| Ampere Rating | % of Current Rating | Opening Time |
|---------------|---------------------|--------------|
| 1A-7A | 100% | >4 hours |
| 1A-7A | 200% | ≤60 sec |
| 1A-7A | 1000% | >1.0ms |

Temperature Derating Curve

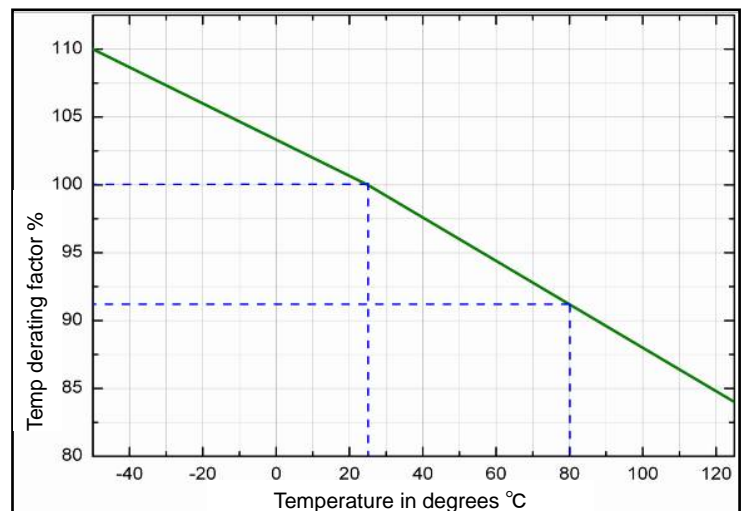
- The current carrying capacity will be affected by ambient temperature which was showed in the figure.
- This current derating curve is for fusing characteristics.

Example,

Work Temp:80°C,

Temp derating factor = 91%

$I_{\text{actual}} = I_{\text{normal}} / 0.91$



Reliability Test

| Item | Test condition / Methods | Performance | Standard |
|---------------------------------|--|--|--|
| Voltage Drop | 100% In; Temperature in fuse was stabilized | Deviation between the mean value:<15% | IEC 60127-1 |
| Time/Current | 100% In | No Fusing;4hours Min. | Refer to SART Spec |
| | 200% In | ≤60 sec | |
| | 1000% In | >1.0ms | |
| Endurance Test | 100% In, 1h on,15min off, 100 cycles; followed by 1h at 125%In | $ \Delta R < 10\%$ Legible appearance | IEC 60127-1 |
| Maximum Sustained Dissipation | 125%In, during the last 10min of the endurance test | changed with current rating | IEC 60127-1 |
| Temperature Rise | 100%In | $ \Delta T < 75^\circ\text{C}$ | UL248-14 |
| Interrupting Ability | 50A/63V DC 50A /63V AC | Without permanent arcing, ignition and bursting of fuse link | UL248-14 |
| Solderability | 240°C±5°C,3sec±0.5sec | 95% coverage Min. | IEC60127-4 IEC60068-2-20 MIL-STD-202 |
| Resistance to Soldering | 260°C±5°C,10sec±0.5sec | $ \Delta R < 10\%$ Legible appearance | MIL-STD-202 IEC60127-4 |
| Bending Test | Distance between holding points: 90mm Bending: 1mm ; time:10sec | $ \Delta R < 10\%$ No mechanical damages | IEC 60127-4 |
| High Temperature Operating Life | 70°C±2°C, 96hours, at 60% In | $ \Delta R < 10\%$; no fusing | MIL-STD-202 Method 108 |
| Low Temperature Storage | -55°C±2 °C, 96hours | $ \Delta R < 10\%$ | IEC60068-2-1 |
| High Temperature Storage | 125°C±2 °C, 96hours | $ \Delta R < 10\%$ | IEC60068-2-2 |
| Humidity (steady state) | 40°C±2°C, 90%~95%RH, 1000hours | $ \Delta R < 10\%$ | MIL-STD-202 Method 103 |
| Salt Spray | 5% salt solution, 48hours exposure | $ \Delta R < 10\%$ Legible appearance | MIL-STD-202 Method 101 |
| Thermal Shock | 5 cycles between -55°C/+125°C, 60 minutes ; each extreme | $ \Delta R < 10\%$ No mechanical damages | IEC 60068-2-14 |

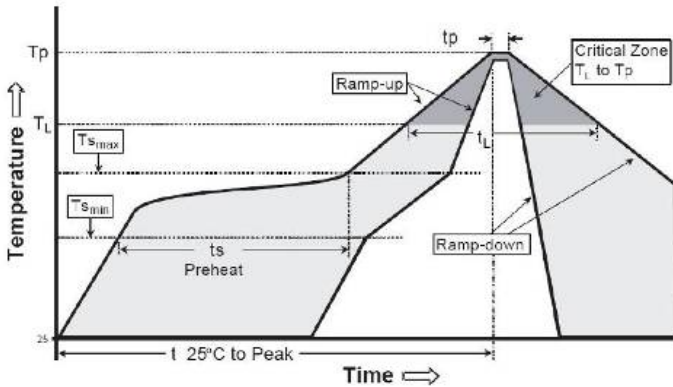
Recommended Solder Curve

1. Infrared Reflow:

Temperature: 260°C

Time: 5sec Max.

Recommend Reflow profile



| Profile Feature | Pb-Free Assembly |
|--|------------------|
| Average Ramp-Up Rate ($T_{s_{max}}$ to T_p) | 3°C/s Max. |
| Preheat Temperature Min ($T_{s_{min}}$) | 150°C |
| Temperature Max ($T_{s_{max}}$) | 200°C |
| Time ($T_{s_{min}}$ to $T_{s_{max}}$) | 60sec~120sec |
| Peak Temperature (T_p) | 260°C |
| Time within 5°C of actual Peak Temperature (T_p) | 5sec |
| Melting tin time (T_L) | 20sec~30sec |
| Ramp-Down Rate | 6°C/s Max. |
| Time 25°C to Peak Temperature | 8 minutes Max. |

2. Wave soldering

Reservoir Temperature: 260°C

Time in Reservoir: 10sec Max.

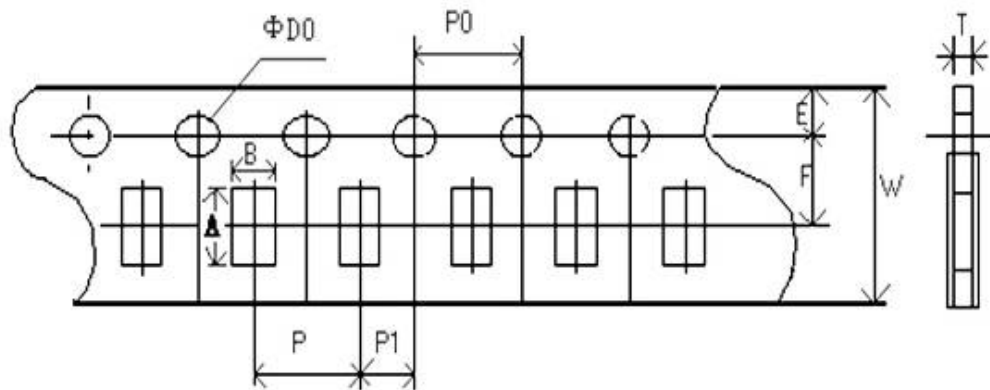
3. Hand Soldering

Temperature: 350°C

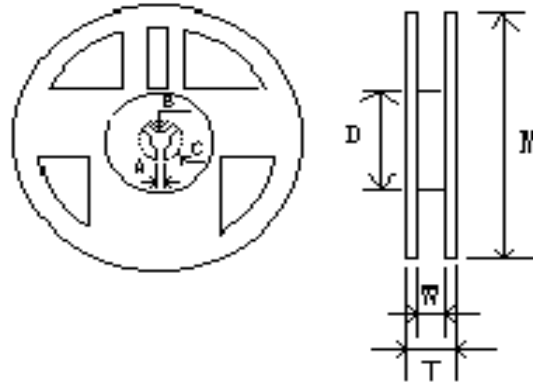
Time: 5sec Max.

Packaging

5,000 pieces of fuses in paper taper and reeled on a 178mm(7 inch) reel



| | | | | | |
|------|-----------|-----------|-----------|-----------|-----------|
| Type | A(mm) | B(mm) | W(mm) | F(mm) | E(mm) |
| Spec | 3.50±0.20 | 1.90±0.20 | 8.00±0.20 | 3.50±0.05 | 1.75±0.10 |
| Type | P(mm) | P0(mm) | P1(mm) | D0(mm) | T(mm) |
| Spec | 4.00±0.10 | 4.00±0.10 | 2.00±0.05 | 1.50±0.10 | 0.75±0.10 |



| Type | M(mm) | W(mm) | T(mm) | A(mm) | B(mm) | C(mm) | D(mm) |
|------|-------------|-----------|------------|-----------|------------|------------|------------|
| Spec | 178.00±2.00 | 9.50±1.00 | 12.50±1.50 | 2.00±0.50 | 13.00±0.50 | 21.00±0.50 | 58.00±2.00 |

Storage

- The ambient temperature shall between 5°C~30°C.
- The relative humidity recommended for storage is between 25%~60%.
- Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.

单击下面可查看定价，库存，交付和生命周期等信息

[>>SART\(萨特\)](#)